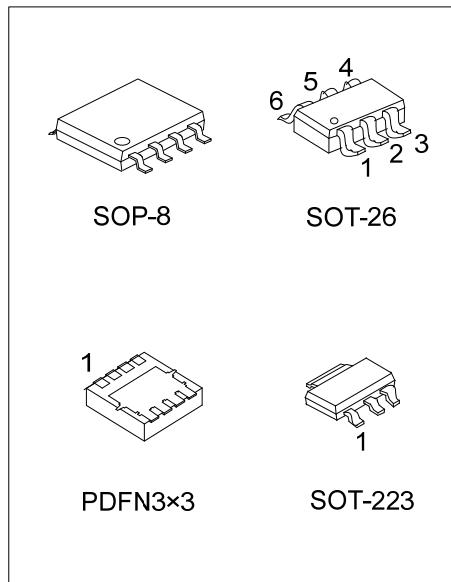
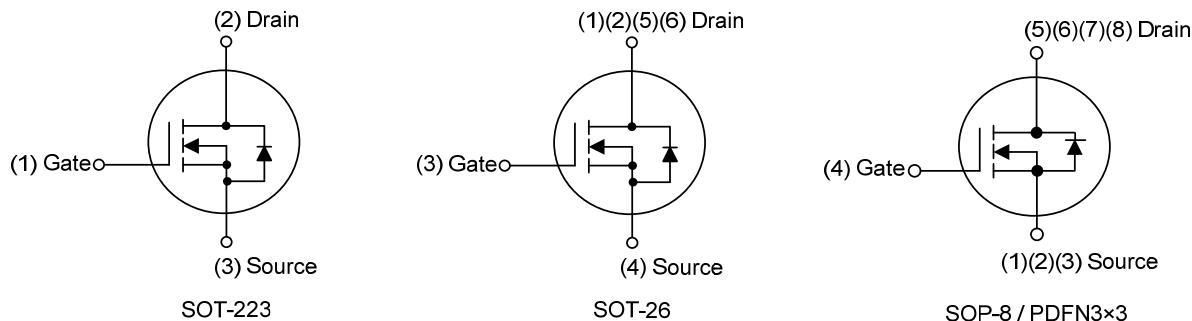


UT5N15**POWER MOSFET****5.0A, 150V N-CHANNEL
POWER MOSFET****■ DESCRIPTION**

The UTC **UT5N15** is a high voltage power MOSFET combines advanced trench MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \leq 0.32 \Omega$ @ $V_{GS}=10V$, $I_D=2.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

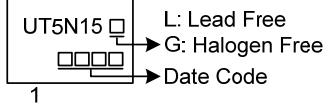
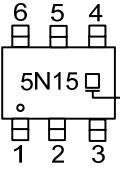
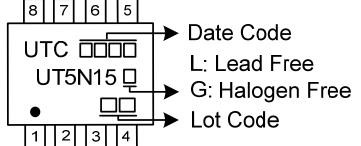
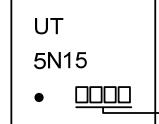
**■ SYMBOL****■ ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT5N15L-AA3-R	UT5N15G-AA3-R	SOT-223	G	D	S	-	-	-	-	-	Tape Reel
UT5N15L-AG6-R	UT5N15G-AG6-R	SOT-26	D	D	G	S	D	D	-	-	Tape Reel
UT5N15L-S08-R	UT5N15G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UT5N15L-P3030-R	UT5N15G-P3030-R	PDFN3x3	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 (1) Packing Type (2) Package Type (3) Green Package	(1) R: Tape Reel							
	(2) AA3: SOT-223, AG6: SOT-26, S08: SOP-8							
	P3030: PDFN3x3							
	(3) G: Halogen Free and Lead Free, L: Lead Free							

■ MARKING

SOT-223	SOT-26
 <p>L: Lead Free G: Halogen Free Date Code</p>	 <p>6 5 4 5N15 1 2 3 L: Lead Free G: Halogen Free</p>
SOP-8	PDFN3x3
 <p>8 7 6 5 UTC UT5N15 • 1 2 3 4 Date Code L: Lead Free G: Halogen Free Lot Code</p>	 <p>UT 5N15 • Date Code</p>

■ ABSOLUTE MAXIMUM RATING ($T_A=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	150	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	5	A
	Pulsed	I_{DM}	10	A
Avalanche Energy	Single Pulsed (Note 4)	E_{AS}	1.2	mJ
Peak Diode Recovery dv/dt (Note 5)		dv/dt	1.2	V/ns
Power Dissipation (Note 3)	SOT-223	P_D	1.2	W
	SOT-26		0.4	W
	SOP-8		1	W
	PDFN3x3		1.4	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-55 ~ +150	$^\circ\text{C}$

- Notes:
1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
 3. Surface mounted on 1 in² copper pad of FR-4 board. 270°C/W when mounted on minimum copper pad.
 4. L = 0.1mH, $I_{AS} = 4.8\text{A}$, $V_{DD} = 20\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
 5. $I_{SD} \leq 5.0 \text{ A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223	θ_{JA}	104	$^\circ\text{C}/\text{W}$
	SOT-26		350	$^\circ\text{C}/\text{W}$
	SOP-8		125	$^\circ\text{C}/\text{W}$
	PDFN3x3		89	$^\circ\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

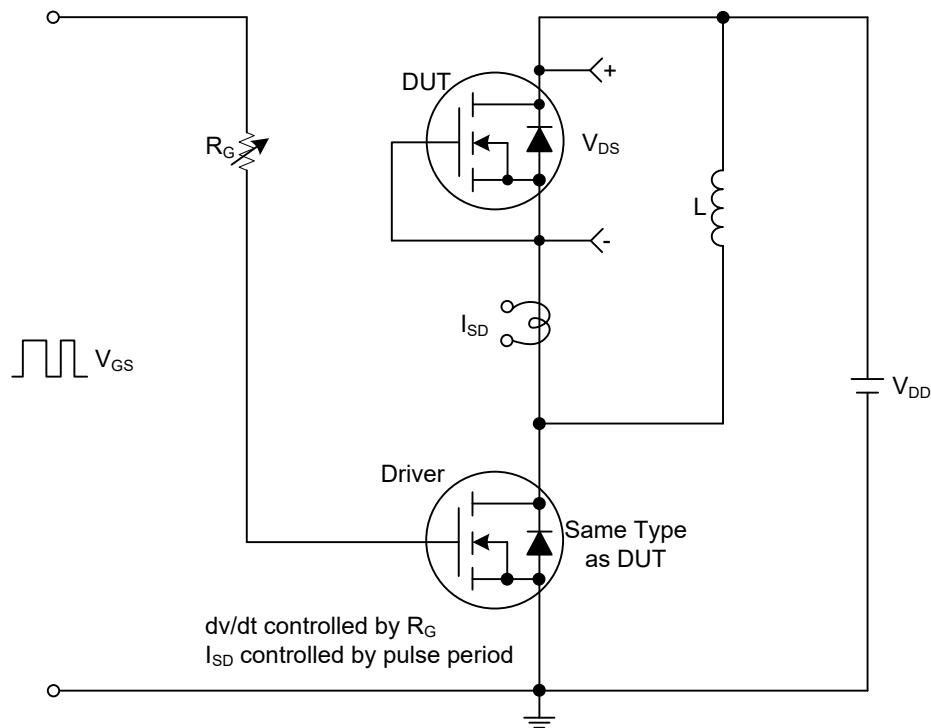
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	150			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=150\text{V}, V_{GS}=0\text{V}$			10	μA
Gate-Source Leakage Current	Forward	$V_{GS}=+20\text{V}, V_{DS}=0\text{V}$			+100	nA
	Reverse	$V_{GS}=-20\text{V}, V_{DS}=0\text{V}$			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=2.5\text{A}$			0.32	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		380		pF
Output Capacitance	C_{OSS}			40		pF
Reverse Transfer Capacitance	C_{RSS}			22		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q_G	$V_{DS}=120\text{V}, V_{GS}=10\text{V}, I_D=5.0\text{A}$ $I_G=1\text{mA}$ (Note 1, 2)		16.2		nC
Gate to Source Charge	Q_{GS}			4.2		nC
Gate to Drain Charge	Q_{GD}			4.4		nC
Turn-on Delay Time (Note 1)	$t_{D(\text{ON})}$	$V_{DD}=100\text{V}, V_{GS}=10\text{V}, I_D=5.0\text{A},$ $R_G=25\Omega$ (Note 1, 2)		6		ns
Rise Time	t_R			18		ns
Turn-off Delay Time	$t_{D(\text{OFF})}$			24		ns
Fall-Time	t_F			23		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				5	A
Maximum Body-Diode Pulsed Current	I_{SM}				10	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$I_S=5.0\text{A}, V_{GS}=0\text{V}$			1.4	V
Reverse Recovery Time	t_{rr}	$I_S=5.0\text{A}, V_{GS}=0\text{V}, dI/dt=100\text{A}/\mu\text{s}$		54		ns
Reverse Recovery Charge	Q_{rr}			90		nC

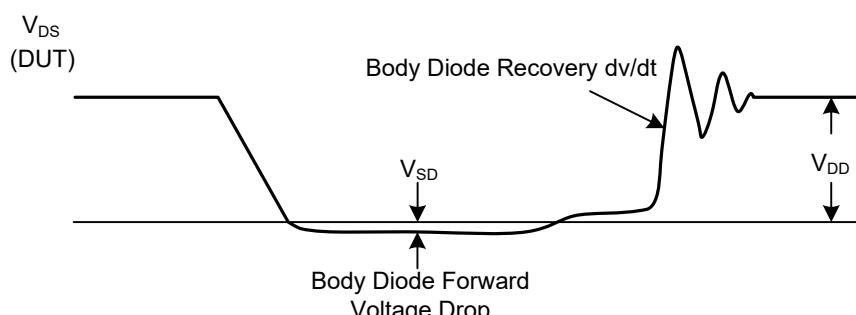
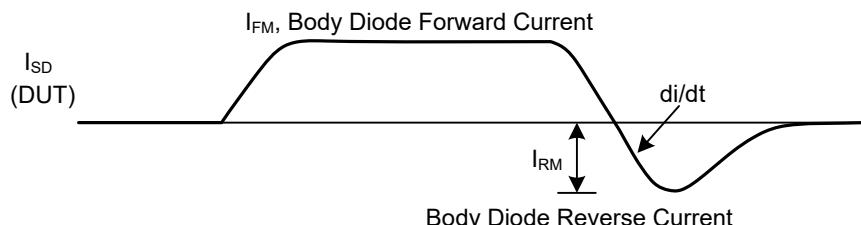
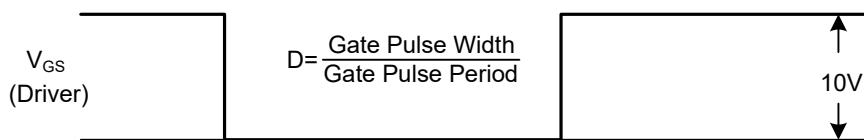
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



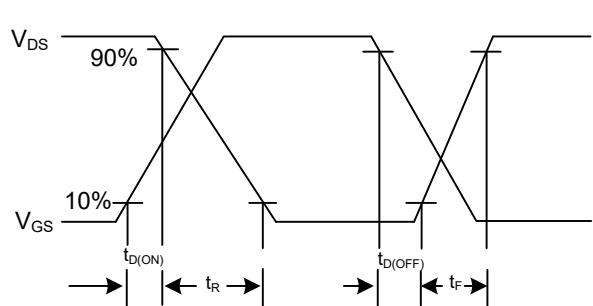
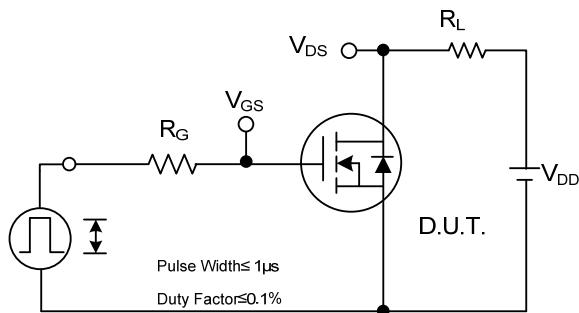
Peak Diode Recovery dV/dt Test Circuit



Peak Diode Recovery dV/dt Test Circuit and Waveforms

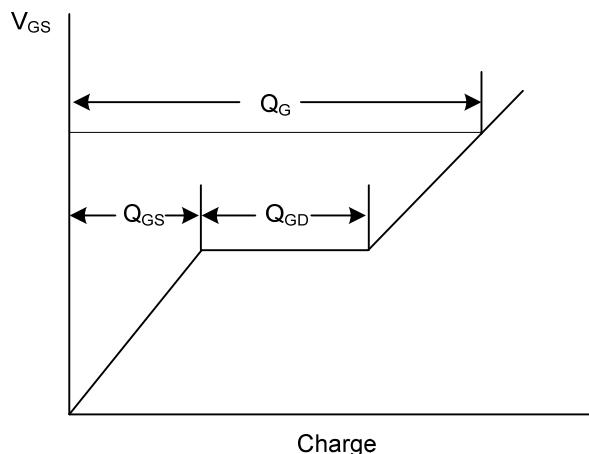
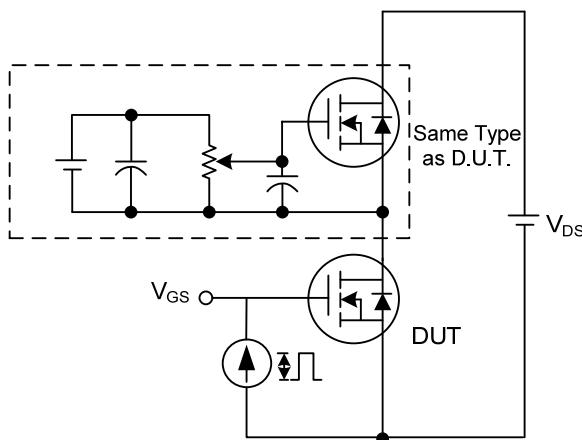
Peak Diode Recovery dV/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS



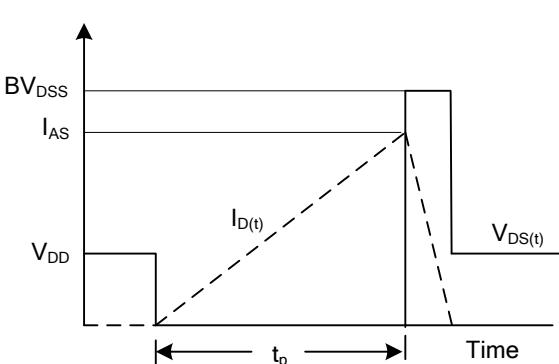
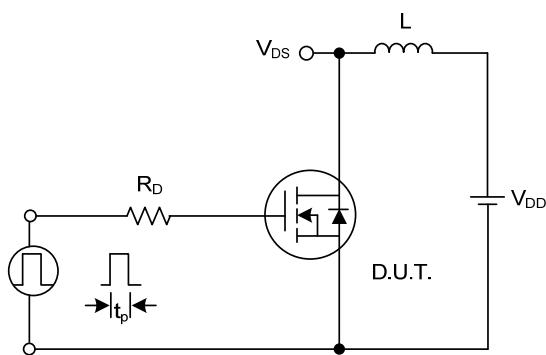
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

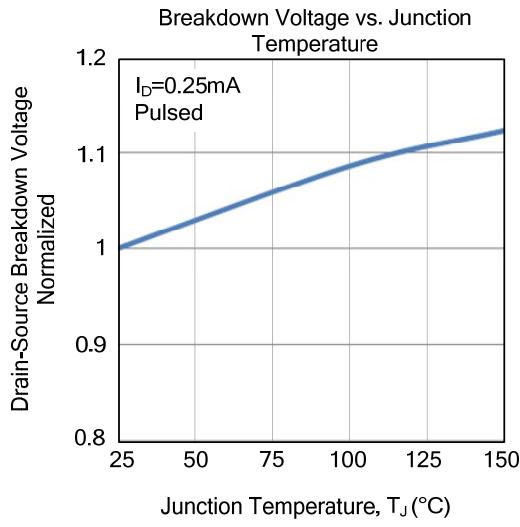
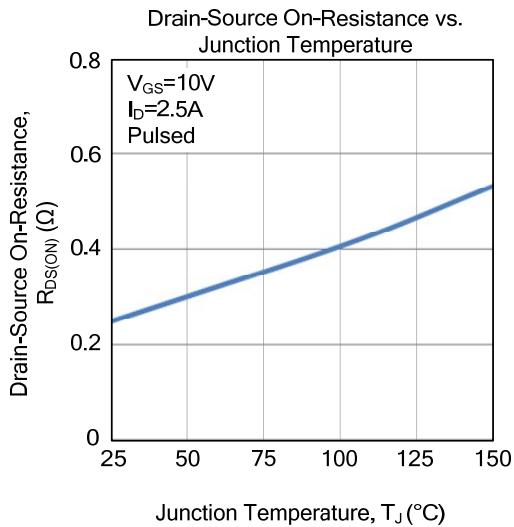
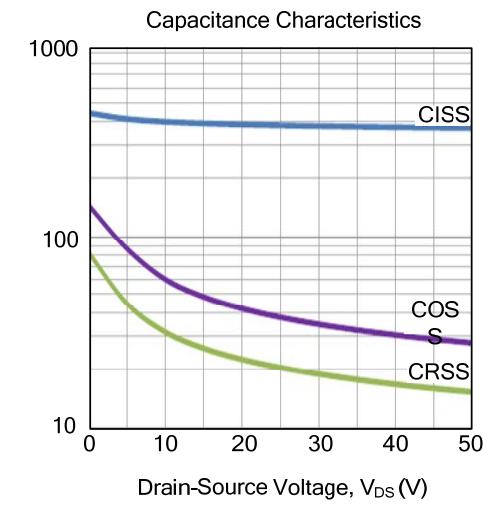
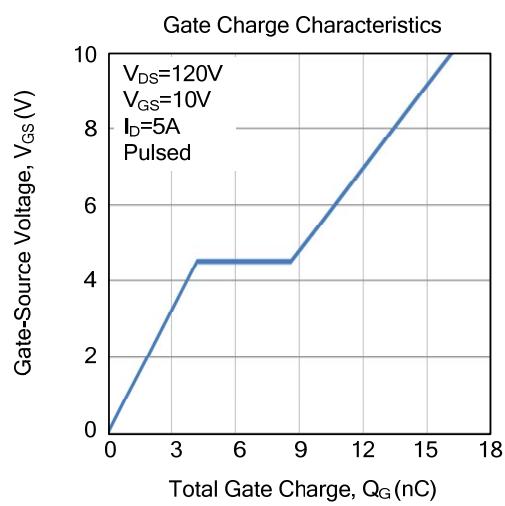
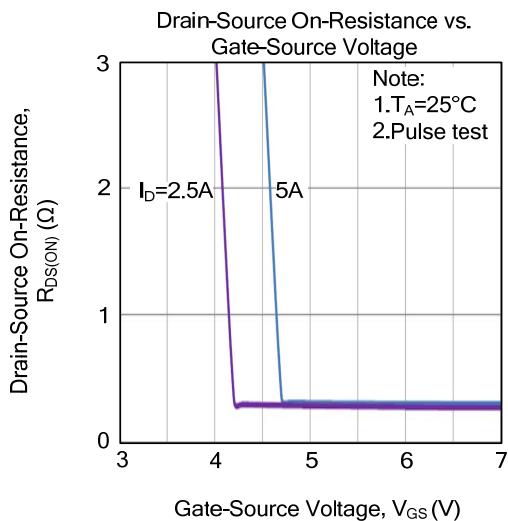
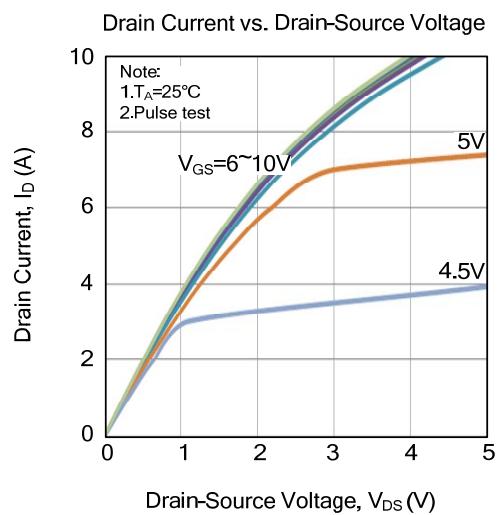
Gate Charge Waveform



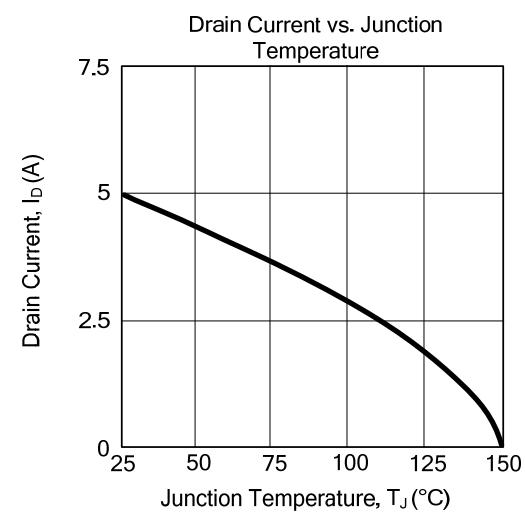
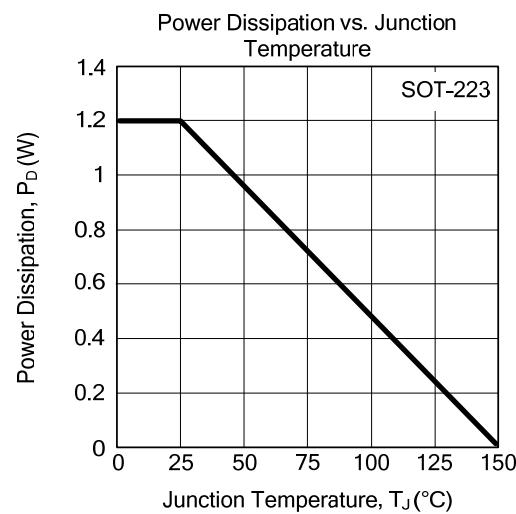
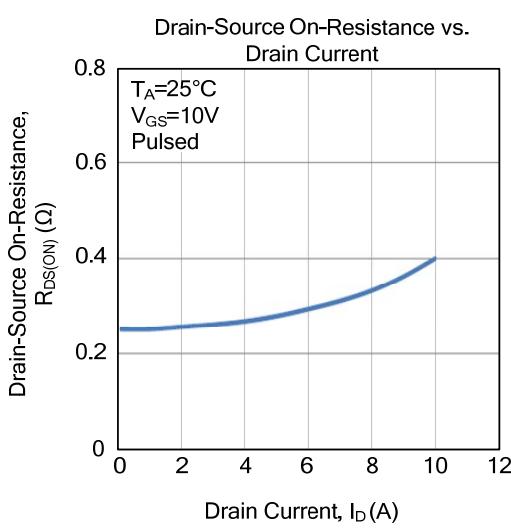
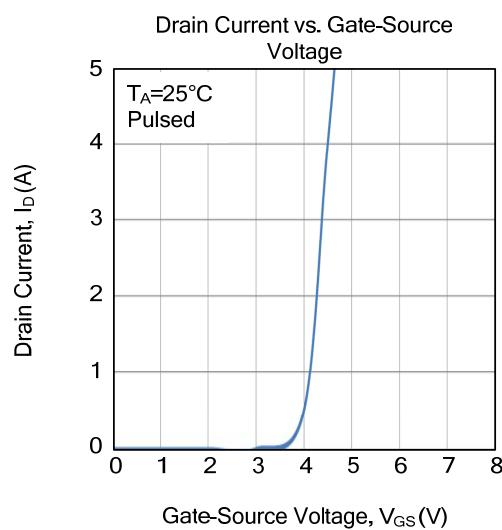
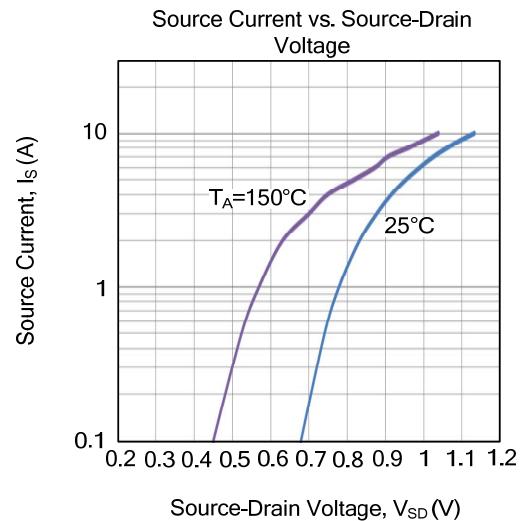
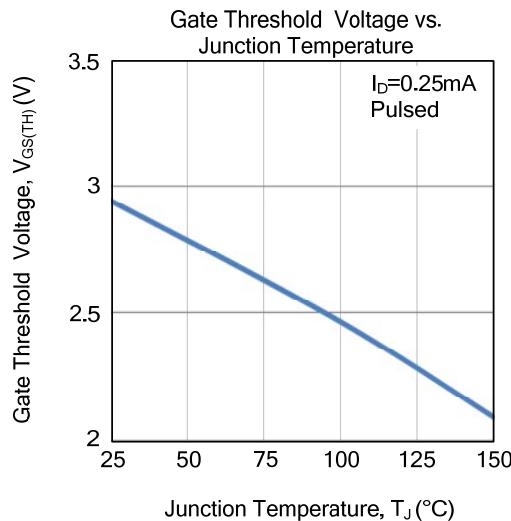
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

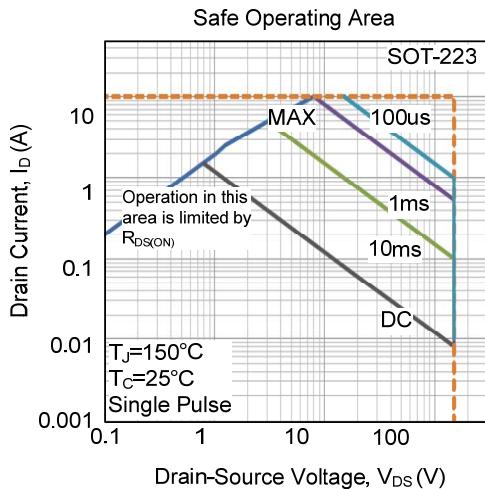
■ TYPICAL CHARACTERISTICS



- TYPICAL CHARACTERISTICS (Cont.)



- TYPICAL CHARACTERISTICS (Cont.)



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